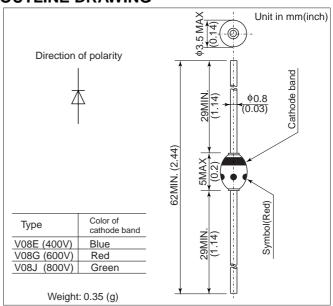
V08

FEATURES

- Transient surge voltage protection.
- Diffused-junction. Glass passivated and encapsulated.

OUTLINE DRAWING



ABSOLUTE MAXIMUM RATINGS

Items	Type		V08E	V08G	V08J				
Repetitive Peak Reverse Voltage	V_{RRM}	V	400	600	800				
Peak Reverse Power	P _{RM}	W	40(Tj = 165°C,Pulse duration 1ms Non-repetitive)						
Average Forward Current	I _{F(AV)}	А	1.1 (Single-phase half sine wave 180° conduction $T_L=90^{\circ}$ C, Lead length = 10° C						
Surge(Non-Repetitive) Forward Current	I _{FSM}	Α	35(Without PIV, 10ms conduction, Tj = 175°C start)						
I ² t Limit Value	l ² t	A ² s	4.9(Time = 2 ~ 10ms, I = RMS value)						
Operating Junction Temperature	Tj	°C	-65 ~ +175						
Storage Temperature	T _{stg}	°C	-65 ~ +200						

Notes (1) Lead mounting: Lead temperature 300°C max. to 3.2mm from body for 5sec. max..

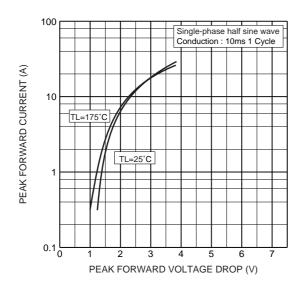
(2) Mechanical strength: Bending 90°×2 cycles or 180°×1 cycle, Tensile 2kg, Twist 90°×1 cycle.

CHARACTERISTICS(T,=25°C)

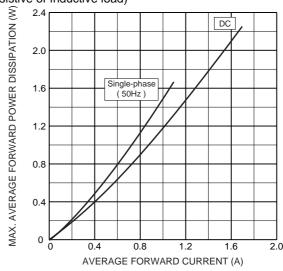
CHARACTERISTICS(T _L =25 C)										
Items	Symbols	Units	Min.	Тур.	Max.	Test Conditions				
Peak Reverse Current	I _{RRM}	μΑ	_	0.6	10	All class, Rated V _{RRM}				
Peak Forward Voltage	V_{FM}	V	_	_	1.4	I _{FM} =1.1Ap, Single-phase half sine wave 1 cycle				
Reverse Recovery Time	trr	μs	_	3.0	_	I _F =2mA, V _R =-15V				
Avalanche Voltage	V_{AVL}	V	V _{RRM}	_	1600	I _{RM} =1.0mA, Single-phase half sine wave 1 pps, Time ≤ 5s				
Steady State Thermal Impedance	$R_{th(j-a)}$ $R_{th(j-l)}$	°C/W	_	_	80 50	Lead length = 10 mm				

V08

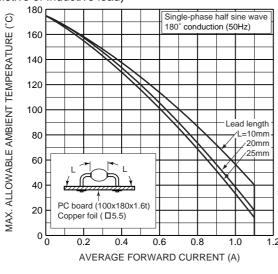
Forward characteristics



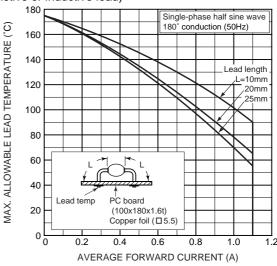
Max. average forward power dissipation (Resistive or inductive load)



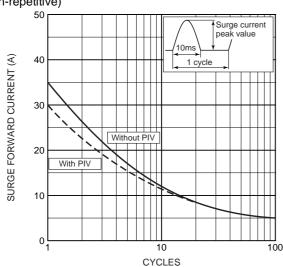
Max. allowable ambient temperature (Resistive or inductive load)



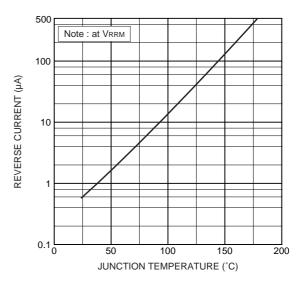
Max. allowable lead temperature (Resistive or inductive load)



Surge forward current characteristic (Non-repetitive)

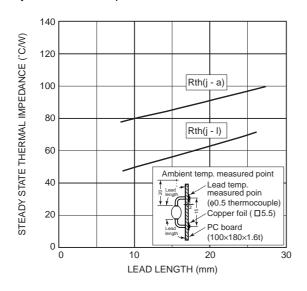


Typ. Reverse current vs. junction temperature

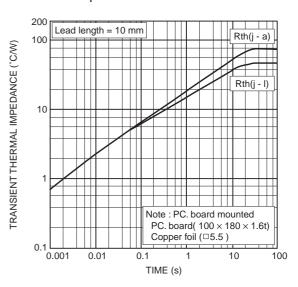


V08

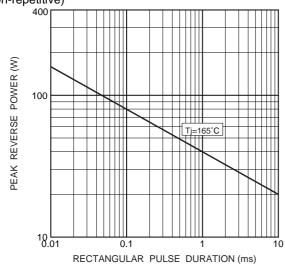
Steady-state thermal impedance



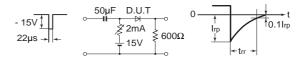
Transient thermal impedance



Typical reverse power characteristic (Non-repetitive)



Reverse recovery time (trr) test circuit



HITACHI POWER SEMICONDUCTORS

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